

Description

The VST15N082 uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

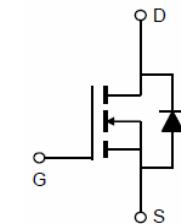
- $V_{DS} = 150V, I_D = 110A$
- $R_{DS(ON)} < 9m\Omega @ V_{GS}=10V$
- Excellent gate charge $\times R_{DS(on)}$ product(FOM)
- Very low on-resistance $R_{DS(on)}$
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



TO-263



Schematic Diagram

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VST15N082-T3	VST15N082	TO-263	-	-	-

Absolute Maximum Ratings ($T_c=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	150	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous	I_D	110	A
Drain Current-Continuous($T_c=100^\circ C$)	$I_D (100^\circ C)$	93	A
Pulsed Drain Current	I_{DM}	440	A
Maximum Power Dissipation	P_D	300	W
Derating factor		2	W/ $^\circ C$
Single pulse avalanche energy ^(Note 5)	E_{AS}	1296	mJ
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 To 175	$^\circ C$

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	$R_{\theta JC}$	0.5	°C/W
--	-----------------	-----	------

Electrical Characteristics ($T_c=25^\circ\text{C}$ unless otherwise noted)

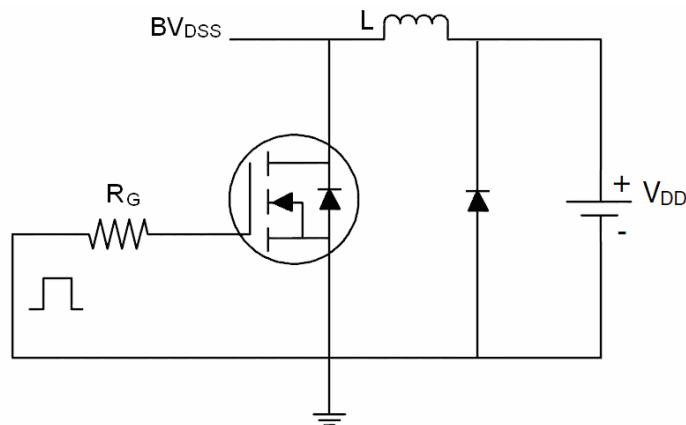
Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_{\text{D}}=250\mu\text{A}$	150	160	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$\text{V}_{\text{DS}}=150\text{V}, \text{V}_{\text{GS}}=0\text{V}$	-	-	1	μA
Gate-Body Leakage Current	I_{GSS}	$\text{V}_{\text{GS}}=\pm20\text{V}, \text{V}_{\text{DS}}=0\text{V}$	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$\text{V}_{\text{GS}(\text{th})}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_{\text{D}}=250\mu\text{A}$	2	3.3	4	V
Drain-Source On-State Resistance	$\text{R}_{\text{DS}(\text{ON})}$	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_{\text{D}}=55\text{A}$	-	8.2	9	$\text{m}\Omega$
Forward Transconductance	g_{FS}	$\text{V}_{\text{DS}}=10\text{V}, \text{I}_{\text{D}}=55\text{A}$	70	-	-	S
Dynamic Characteristics (Note 4)						
Input Capacitance	C_{iss}	$\text{V}_{\text{DS}}=75\text{V}, \text{V}_{\text{GS}}=0\text{V},$ $F=1.0\text{MHz}$	-	5500	-	PF
Output Capacitance	C_{oss}		-	540	-	PF
Reverse Transfer Capacitance	C_{rss}		-	5	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$\text{V}_{\text{DD}}=75\text{V}, \text{I}_{\text{D}}=55\text{A}$ $\text{V}_{\text{GS}}=10\text{V}, \text{R}_{\text{G}}=4.7\Omega$	-	25	-	nS
Turn-on Rise Time	t_{r}		-	35	-	nS
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$		-	46	-	nS
Turn-Off Fall Time	t_{f}		-	14	-	nS
Total Gate Charge	Q_{g}	$\text{V}_{\text{DS}}=75\text{V}, \text{I}_{\text{D}}=55\text{A},$ $\text{V}_{\text{GS}}=10\text{V}$	-	74	-	nC
Gate-Source Charge	Q_{gs}		-	32	-	nC
Gate-Drain Charge	Q_{gd}		-	7.3	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V_{SD}	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_{\text{F}}= \text{I}_{\text{S}}$	-		1.2	V
Diode Forward Current (Note 2)	I_{S}		-	-	110	A
Reverse Recovery Time	t_{rr}	$\text{T}_J = 25^\circ\text{C}, \text{I}_{\text{F}} = \text{I}_{\text{S}}$ $d\text{i}/dt = 100\text{A}/\mu\text{s}$ (Note 3)	-	145	-	nS
Reverse Recovery Charge	Q_{rr}		-	480	-	nC

Notes:

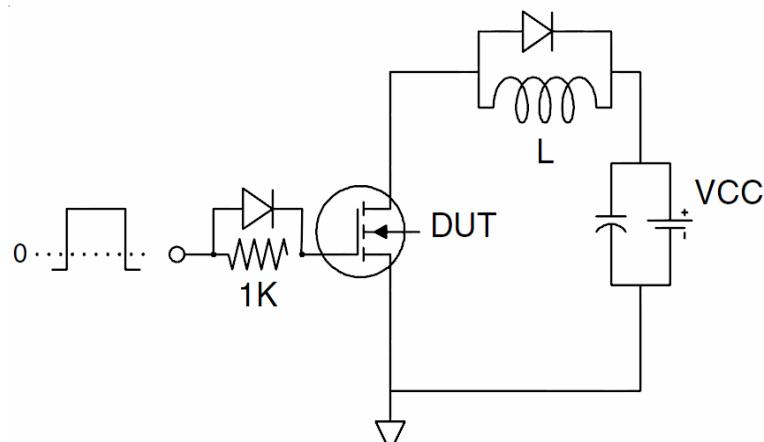
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production
5. EAS condition : $\text{T}_J=25^\circ\text{C}, \text{V}_{\text{DD}}=50\text{V}, \text{V}_{\text{G}}=10\text{V}, \text{L}=0.5\text{mH}, \text{R}_{\text{g}}=25\Omega$

Test Circuit

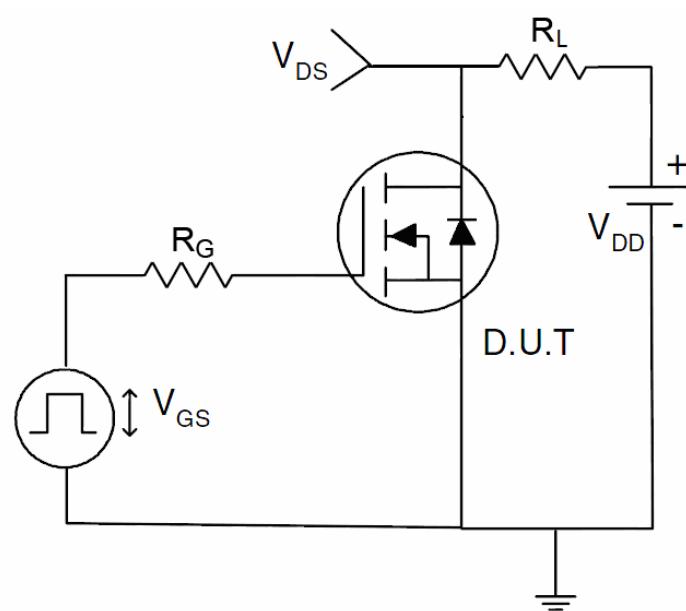
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit



Typical Electrical and Thermal Characteristics

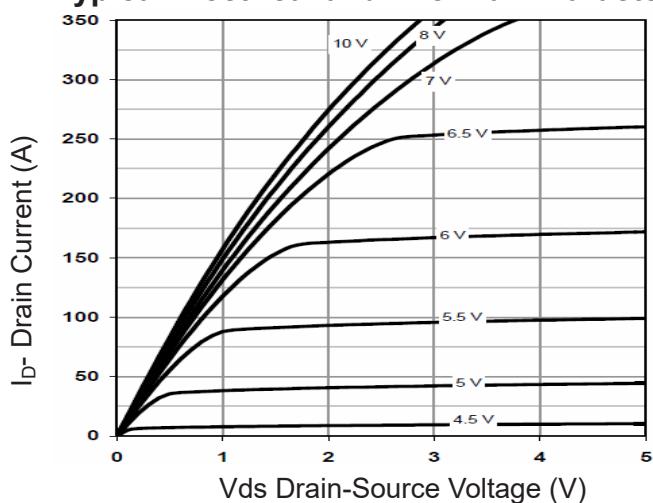


Figure 1 Output Characteristics

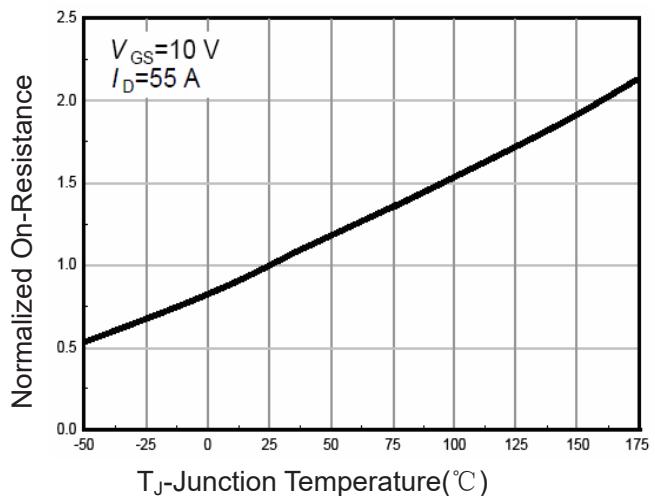


Figure 4 Rdson-JunctionTemperature

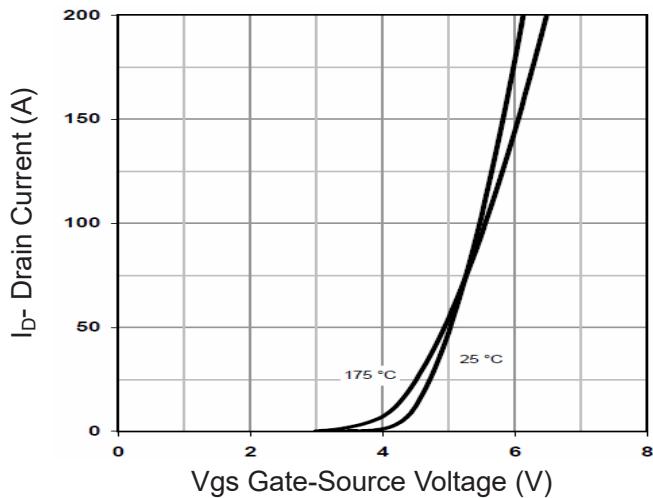


Figure 2 Transfer Characteristics

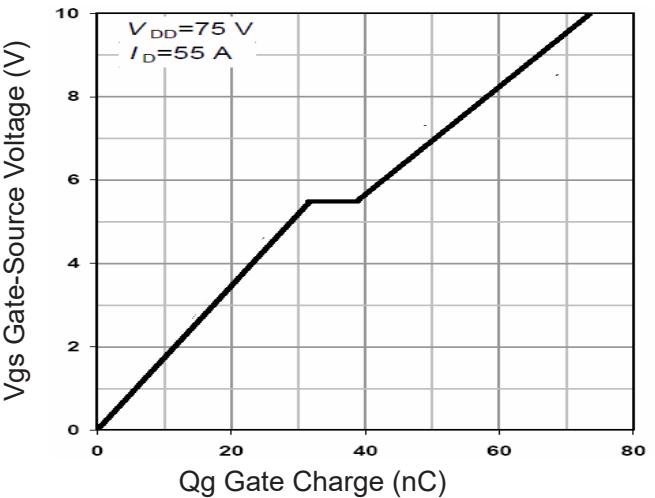


Figure 5 Gate Charge

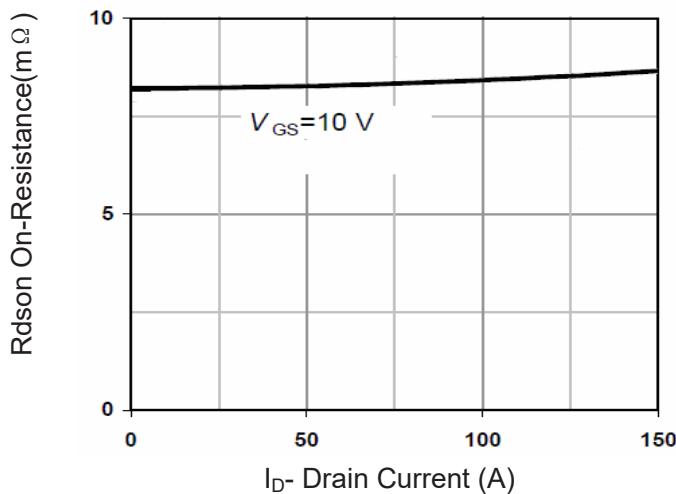


Figure 3 Rdson- Drain Current

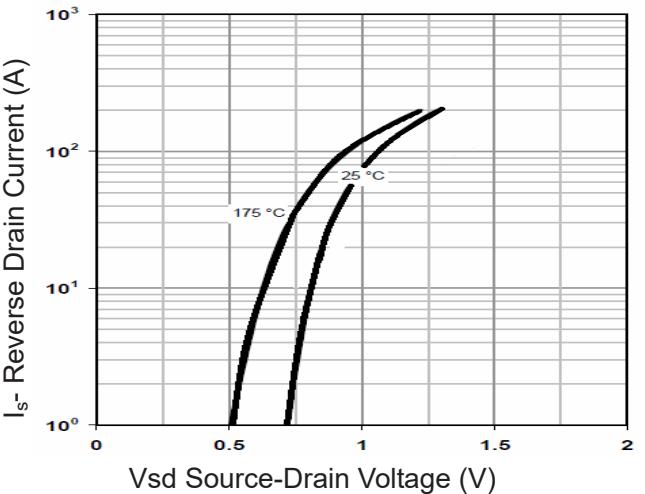
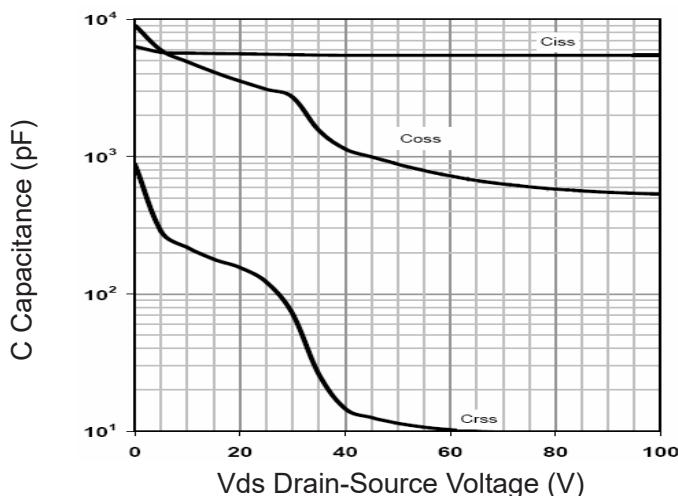
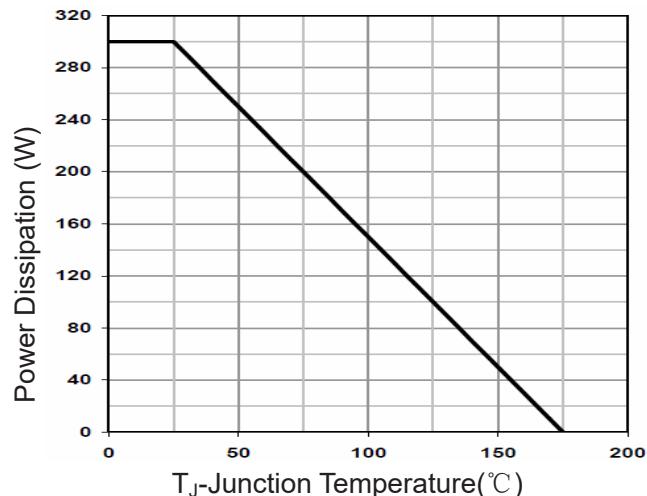
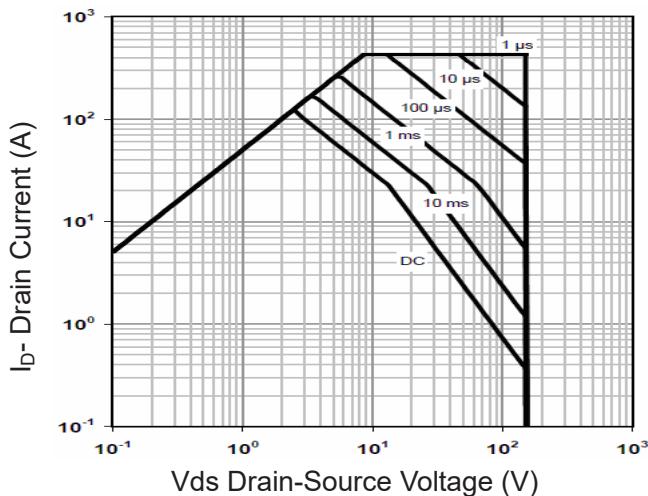
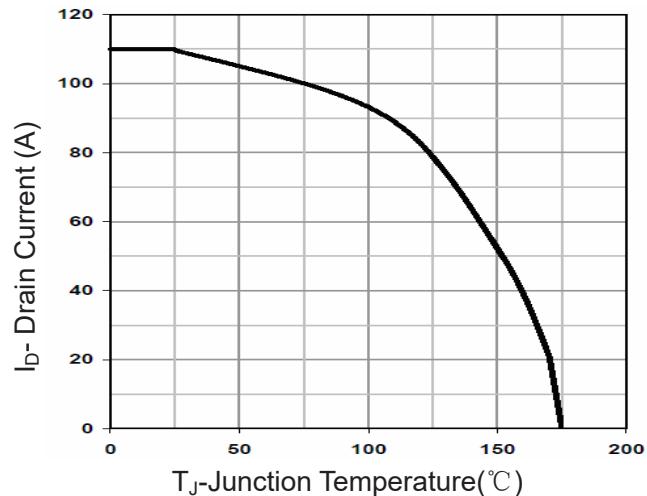
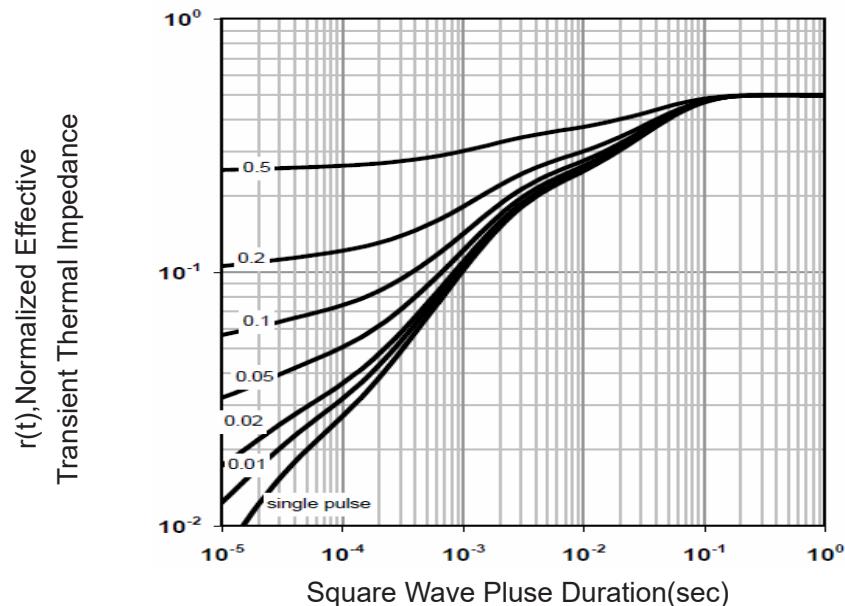


Figure 6 Source- Drain Diode Forward


Figure 7 Capacitance vs Vds

Figure 9 Power De-rating

Figure 8 Safe Operation Area

Figure 10 Current De-rating

Figure 11 Normalized Maximum Transient Thermal Impedance